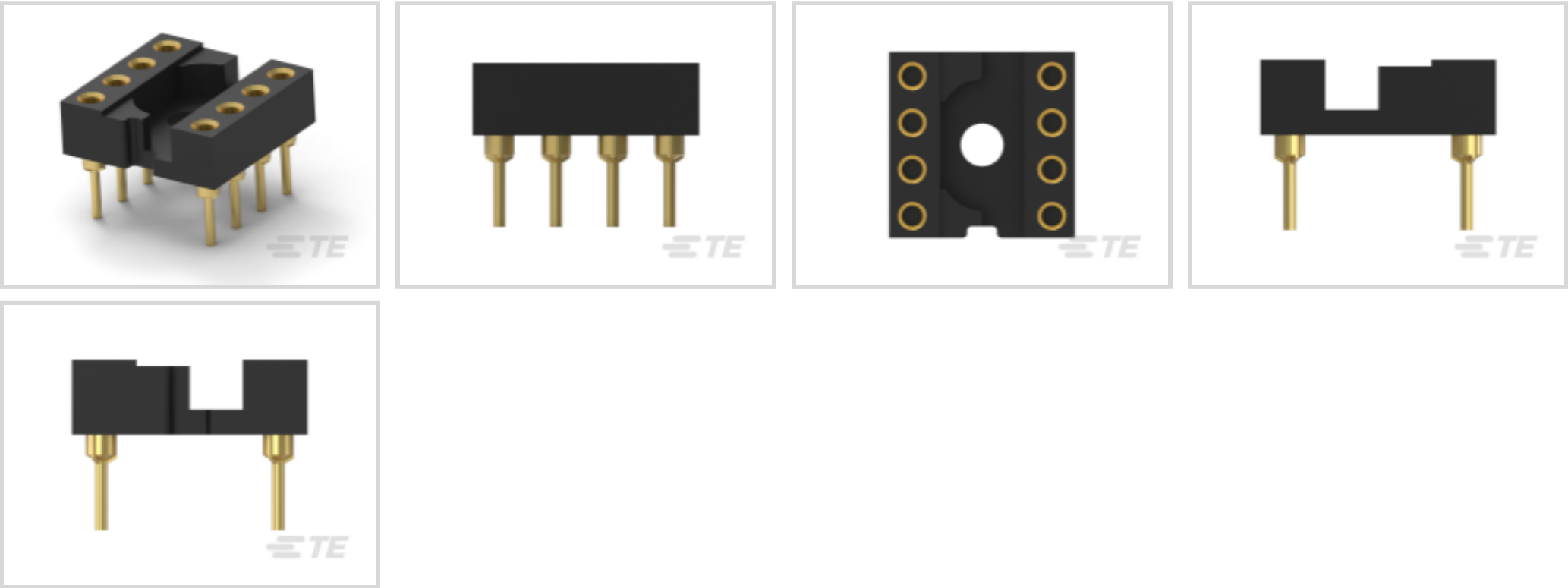




Connectors > Socket Connectors > IC Sockets > DIP Sockets



Contact Fabrication: Solid

Number of Positions: 8

Connector Profile: Standard

Row-to-Row Spacing: 7.62 mm [.3 in]

Contact Mating Area Plating Material: Gold (Au)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
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Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	8

Body Features

Frame Style	Open
Connector Profile	Standard

Contact Features

Contact Fabrication	Solid
Contact Mating Area Plating Material	Gold (Au)
Contact Mating Area Plating Material Thickness	.63 µm[25 µin]
Contact Current Rating (Max)	3 A

Termination Features

Termination Method to PCB	Through Hole - Solder
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Mechanical Attachment



Connector Mounting Type	Board Mount
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Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
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Dimensions

Row-to-Row Spacing	7.62 mm[.3 in]
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Operation/Application

Circuit Application	Signal
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Product Compliance

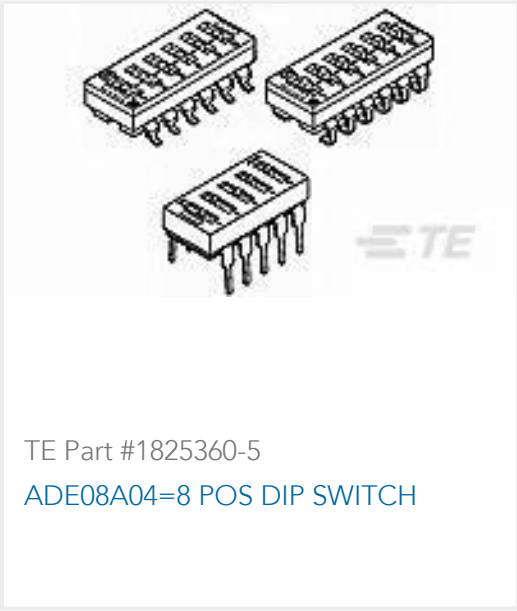
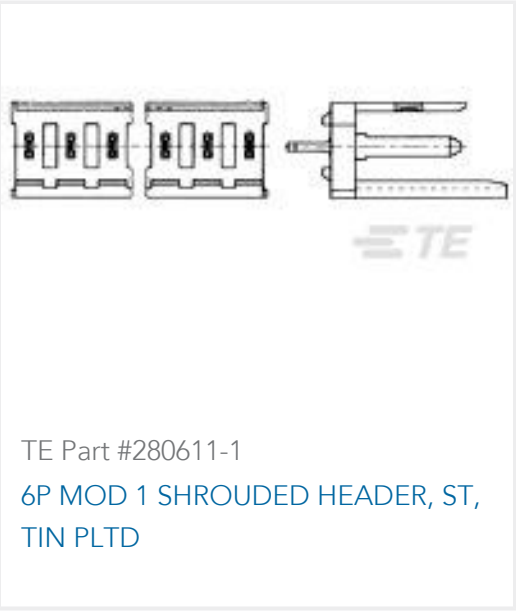
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量超出标准 Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (13% in COMPONENT PART) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Customers Also Bought



Documents

Product Drawings

508-AG11D=SOCKET ASSY

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_7-1437529-9_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_7-1437529-9_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_7-1437529-9_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

DIP Sockets Quick Reference Guide (EN)

English